

**TOPAZ**  
 SEMICONDUCTOR

**TZ404**

**N-CHANNEL ENHANCEMENT-MODE D-MOS FET  
 ULTRA HIGH-SPEED LOW-COST SWITCH**

**ORDERING INFORMATION**

TO-92 Plastic Package	TZ404BD
SOT-89 Surface Mount Package	TZ404CY
Description	20V, 8 ohm

**FEATURES**

- Reliable, Low Cost, Plastic Package
- High Speed Switching,  $t_r < 2\text{nSec}$
- Low Capacitance,  $c_{rss}$  1.2 pF typ
- CMOS and TTL Compatible Input
- Available in Surface Mount Package

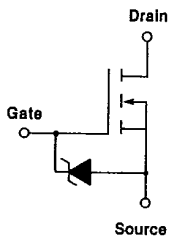
**APPLICATIONS**

- Switch Drivers
- Video Switches
- VHF/UHF Amplifiers

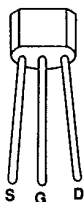
**ABSOLUTE MAXIMUM RATINGS** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

Drain-Source Voltage	+20V	Peak Pulsed Drain Current	+0.8A
Gate-Source Voltage	-0.3V	Continuous Drain Current	100mA
	+20V	Power Dissipation (at or below $T_A = +25^\circ\text{C}$ )	300mW
Gate-Drain Voltage	-0.3V	Linear Derating Factor	3.0mW/ $^\circ\text{C}$
	+20V	Operating Junction and	
Source-Drain Voltage	-0.3V	Storage Temperature Range	-40 $^\circ\text{C}$ to +125 $^\circ\text{C}$

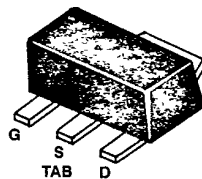
**PIN CONFIGURATIONS**



TO-92



SOT-89



**PACKAGE DIMENSIONS  
 TO-92**

TO-226AA (TO-92)  
 See Package 5

TO-243AA (SOT-89)  
 See Package 23

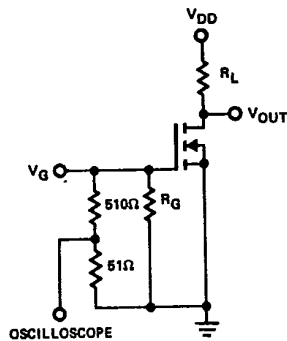
T-35-25

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = +25 °C unless otherwise specified)

CHARACTERISTIC		MIN	TYP	MAX	UNIT	TEST CONDITION
STATIC	BV <sub>DS</sub> Drain-Source Breakdown Voltage	20	25		V	I <sub>D</sub> = 1.0μA, V <sub>GS</sub> = 0
	I <sub>D(off)</sub> Drain-Source OFF Leakage Current			1.0	μA	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0
	I <sub>GSS</sub> Gate-Source Leakage Current			10	μA	V <sub>GS</sub> = 20V, V <sub>DS</sub> = 0
	I <sub>D(on)</sub> Drain-Source ON Current	0.8	1.2		A	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 10V (Note 1)
	V <sub>GS(th)</sub> Gate-Source Threshold Voltage	0.7	1.1	1.5	V	I <sub>D</sub> = 1.0μA, V <sub>DS</sub> = V <sub>GS</sub>
	V <sub>DS(on)</sub> Drain-Source ON Voltage			200	mV	(Note 1)
	r <sub>DS(on)</sub> Drain-Source ON Resistance			20	ohms	
	V <sub>DS(on)</sub> Drain-Source ON Voltage			800	mV	
	r <sub>DS(on)</sub> Drain-Source ON Resistance			8.0	ohms	
DYNAMIC	g <sub>fs</sub> Common-Source Forward Transcond.	100			mmhos	I <sub>D</sub> = 0.3A V <sub>DS</sub> = 20V f = 1KHz
	C <sub>iss</sub> Common-Source Input Capacitance		12	18	pf	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0 f = 1MHz
	C <sub>oss</sub> Common-Source Output Capacitance		6.0	8.0		
	C <sub>rss</sub> Common-Source Reverse Transfer Capacitance		1.2	2.0		
	t <sub>d(on)</sub> Turn ON Delay Time		1.0	1.5	nS	V <sub>DD</sub> = 10V, R <sub>L</sub> = 390Ω V <sub>G(on)</sub> = 10V, R <sub>G</sub> = 51Ω C <sub>L</sub> = 1.5pF
	t <sub>r</sub> Rise Time		1.0	2.0		
t <sub>off</sub> Turn OFF Time		1.0				

Note 1: Pulse Test, 80μSec, 1% Duty Cycle

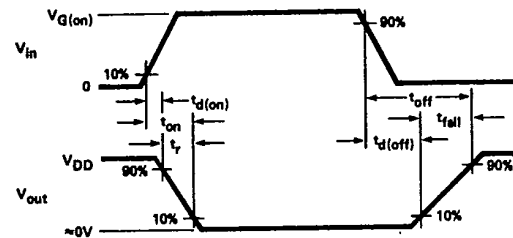
**SWITCHING TIMES TEST CIRCUIT**



INPUT PULSE  
t<sub>r</sub> < 0.5 nSEC  
PULSE WIDTH - 100 nSEC

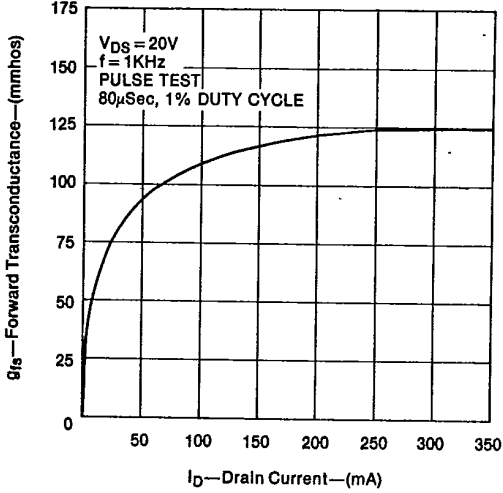
SAMPLING OSCILLOSCOPE  
t<sub>r</sub> < 0.36 nSEC  
R<sub>in</sub> > 1MΩ  
C<sub>in</sub> < 2.0 pF

**TEST WAVEFORMS**

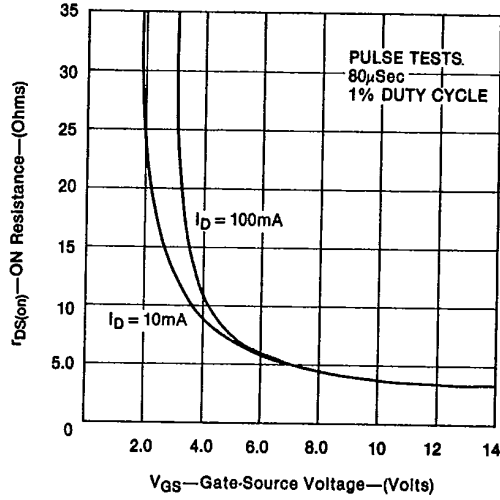


**TYPICAL PERFORMANCE CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

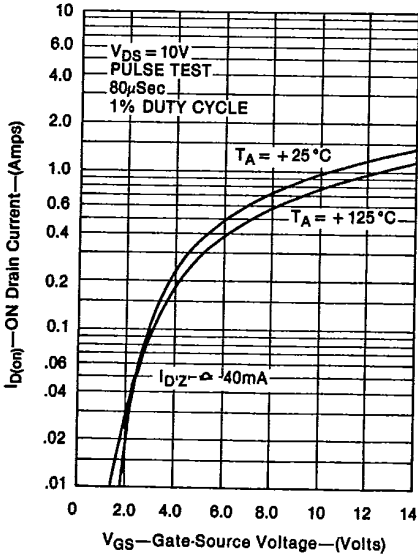
**FORWARD TRANSCONDUCTANCE**  
—vs—  
**ON DRAIN CURRENT**



**DRAIN-SOURCE ON RESISTANCE**  
—vs—  
**GATE-SOURCE VOLTAGE**



**ON DRAIN CURRENT**  
—vs—  
**GATE-SOURCE VOLTAGE**



**CAPACITANCES**  
—vs—  
**DRAIN-SOURCE VOLTAGE**

